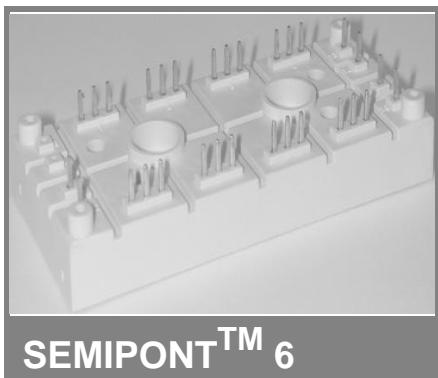


SKDH 116/.. -L100



3-Phase Bridge Rectifier + IGBT braking chopper

SKDH 116/.. -L100

Preliminary Data

Features

- Compact design
- Two screws mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- High surge currents
- Up to 1600V reverse voltage
- UL recognized, file no. E 63 532

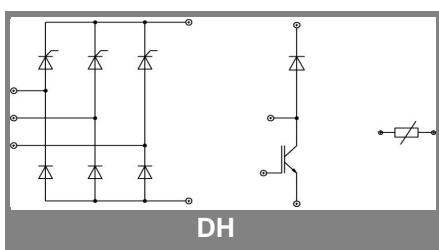
Typical Applications

- DC drives
- Controlled field rectifiers for DC motors
- Controlled battery charger

V_{RSM}	V_{RRM}, V_{DRM}	$I_D = 110 \text{ A}$ (maximum value for continuous operation) $(T_s = 80^\circ\text{C})$ SKDH 116/12-L100 SKDH 116/16-L100
1300	1200	
1700	1600	

Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
Bridge - Rectifier			
I_D	$T_s = 80^\circ\text{C}$; inductive load	110	A
I_{FSM}/I_{TSM}	$t_p = 10 \text{ ms}; \sin 180^\circ; T_{jmax}$	950	A
i^2t	$t_p = 10 \text{ ms}; \sin 180^\circ; T_{jmax}$	4500	A^2s
IGBT - Chopper			
V_{CES}/V_{GES}		1200 / 20	V
I_C	$T_s = 25 (70)^\circ\text{C}$	125 (100)	A
I_{CM}	$t_p = 1 \text{ ms}; T_s = 25 (70)^\circ\text{C}$	250 (200)	A
Freewheeling - CAL Diode			
V_{RRM}		1200	V
I_F	$T_s = 25 (70)^\circ\text{C}$	130 (90)	A
I_{FM}	$t_p = 1 \text{ ms}; T_s = 25 (70)^\circ\text{C}$	240 (180)	A
T_{vj}	Diode & IGBT (Thyristor)	- 40 ... + 150 (-40...+ 125)	$^\circ\text{C}$
T_{stg}		- 40 ... + 125	$^\circ\text{C}$
T_{solder}	terminals, 10 s	260	$^\circ\text{C}$
V_{isol}	a.c. (50) Hz, RMS 1 min. / 1 s	3000 / 3600	V

Characteristics		$T_s = 25^\circ\text{C}$, unless otherwise specified		
Symbol	Conditions	min.	typ.	max.
Diode - Rectifier				
V_{TO} / r_t	$T_j = 125^\circ\text{C}$	0,8 / 7		V / m Ω
$R_{th(j-s)}$	per diode		1	K/W
Thyristor - Rectifier				
$V_{F(TO)} / r_t$	$T_j = 125^\circ\text{C}$	1,1 / 6		V / m Ω
$R_{th(j-s)}$	per Thyristor		0,85	K/W
I_{GD}	$T_j = 125^\circ\text{C}$; d.c.	5		mA
V_{GT} / I_{GT}	$T_j = 25^\circ\text{C}$		3 / 150	V / mA
I_H/I_L	$T_j = 25^\circ\text{C}$	250 / 600		mA
$(dv/dt)_{cr}$	$T_j = 125^\circ\text{C}$	1000		V/ μ s
$(di/dt)_{cr}$	$T_j = 125^\circ\text{C}$	100		A/ μ s
IGBT - Chopper				
$V_{CE(sat)}$	$I_C = 100 \text{ A}; T_j = 25^\circ\text{C}; V_{GE} = 15 \text{ V}$	2,35		V
$R_{th(j-s)}$	per IGBT		0,3	K/W
$t_{d(on)} / t_r$	valid for all values:	114 / 94,5		ns
$t_{d(off)} / t_f$	$V_{CC} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 120 \text{ A}; T_j = 125^\circ\text{C}$	845,4 / 94,5		ns
$E_{on} + E_{off}$	$T_j = 125^\circ\text{C}; R_G = 16 \Omega$; inductive load	24,4		mJ
CAL - Diode - Freewheeling				
$V_{T(TO)} / r_t$	$T_j = 125^\circ\text{C}$	1 / 8	1,2 / 11	V / m Ω
$R_{th(j-s)}$	per diode		0,6	K/W
I_{RRM}	valid for all values:	65		A
Q_{rr}	$I_F = 100 \text{ A}; V_R = -600 \text{ V}; dI_F/dt = -1000 \text{ A}/\mu\text{s}$	15		μ C
E_{off}	$V_{GE} = 0 \text{ V}; T_j = 125^\circ\text{C}$			mJ
Temperature Sensor				
R_{TS}	$T = 25 (100)^\circ\text{C}$	1000 (1670)		Ω
Mechanical data				
M_S	mounting Torque	2,55	3,45	Nm



SKDH 116/.. -L100

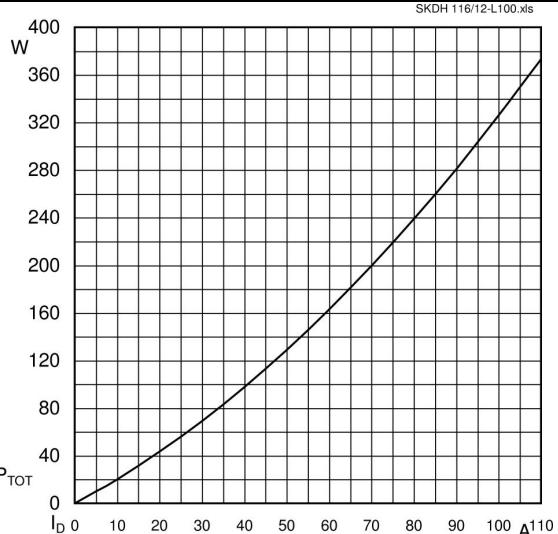


Fig. 1 Power dissipation per module vs. output current

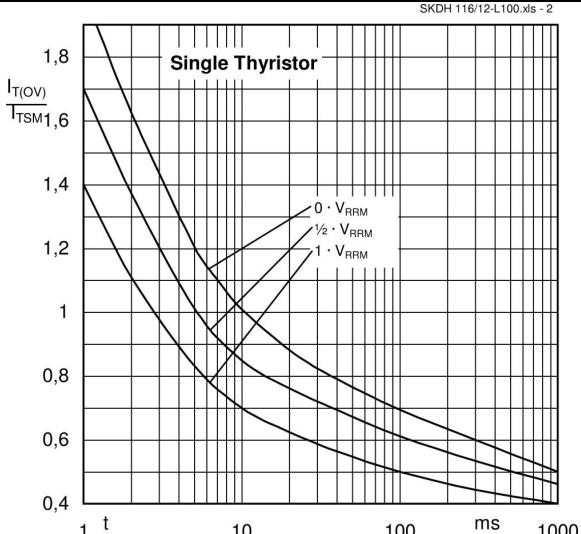


Fig. 2 Surge overload current vs. time

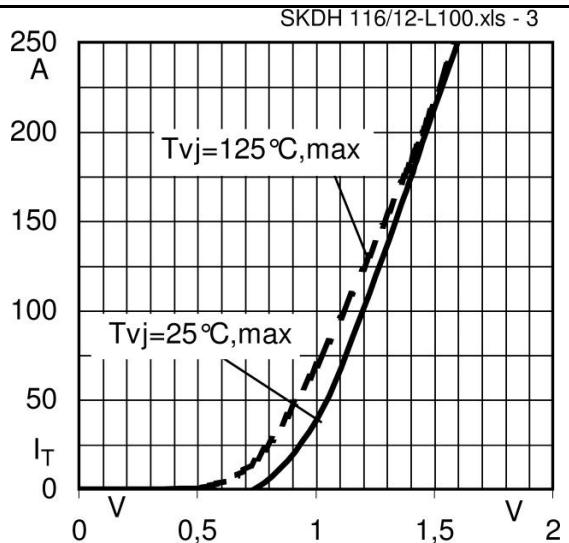


Fig. 3 Forward characteristic of single rectifier diode

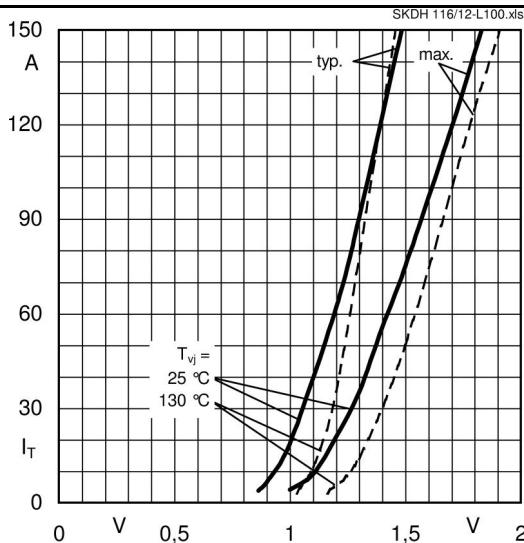


Fig. 4 Forward characteristic of single thyristor

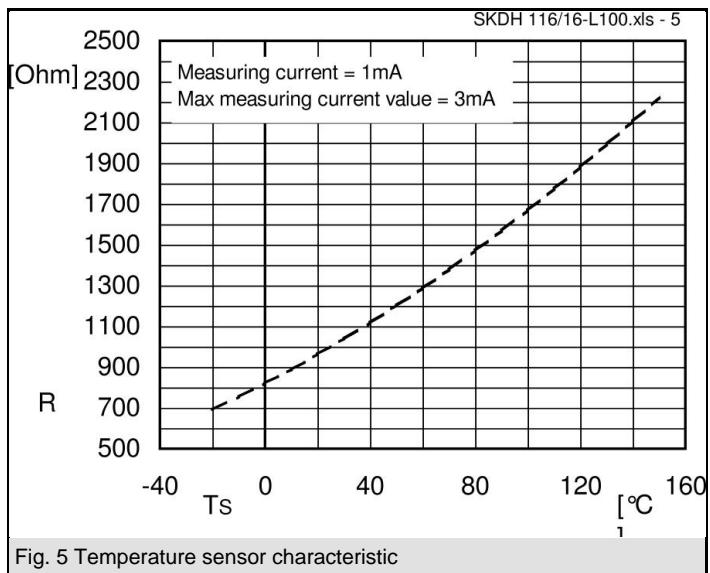


Fig. 5 Temperature sensor characteristic



Fig. 6 Typ gate charge characteristic

SKDH 116/.. -L100

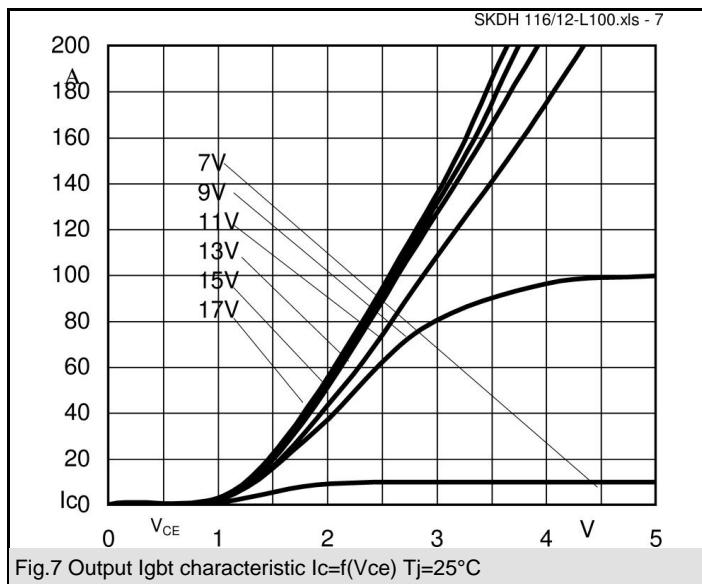


Fig. 7 Output IGBT characteristic $I_c=f(V_{ce})$ $T_j=25^\circ\text{C}$

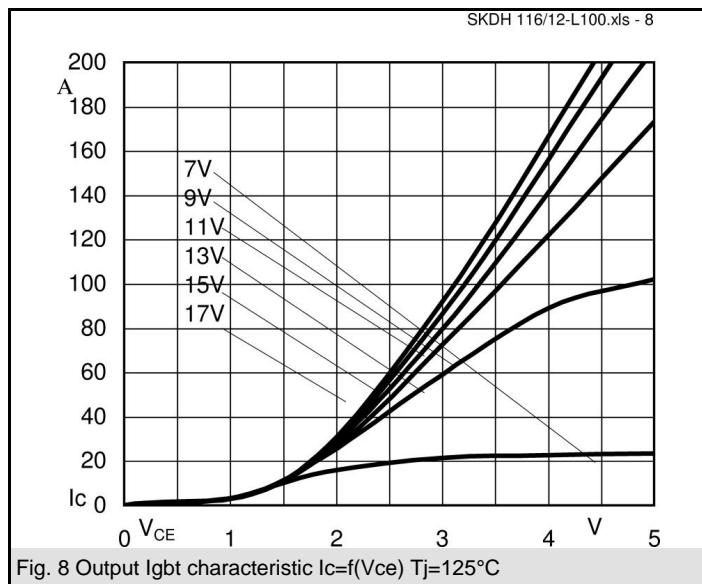


Fig. 8 Output IGBT characteristic $I_c=f(V_{ce})$ $T_j=125^\circ\text{C}$

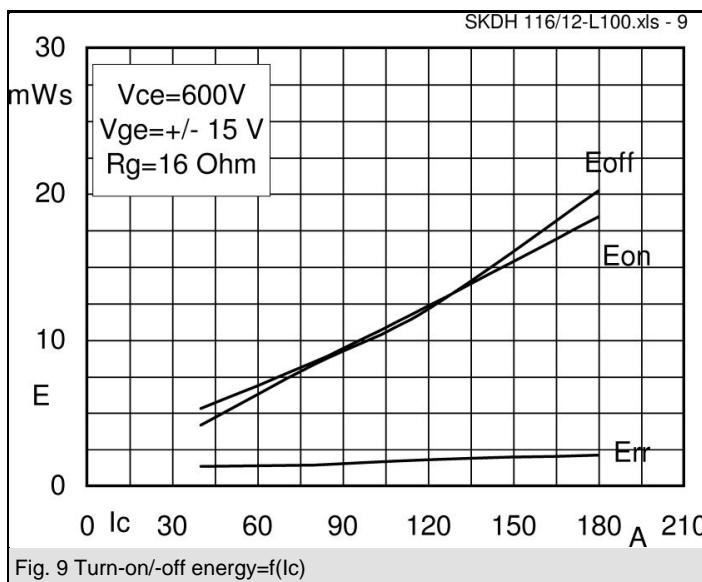


Fig. 9 Turn-on/-off energy=f(I_c)

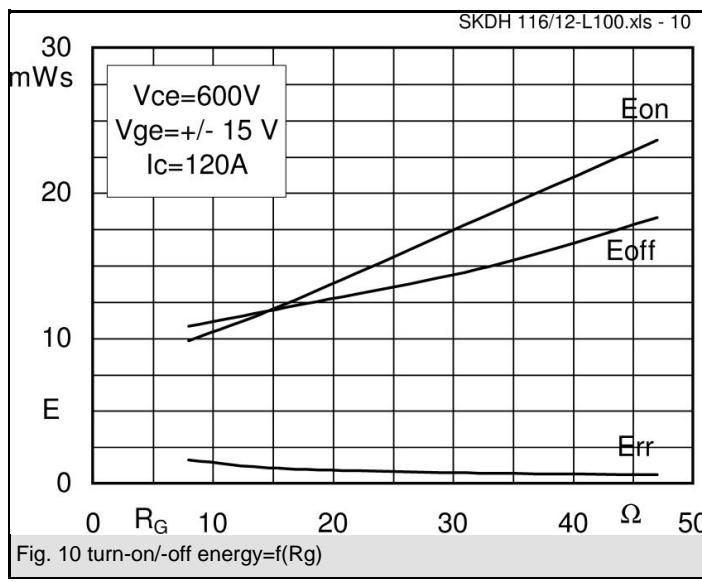


Fig. 10 turn-on/-off energy=f(R_g)

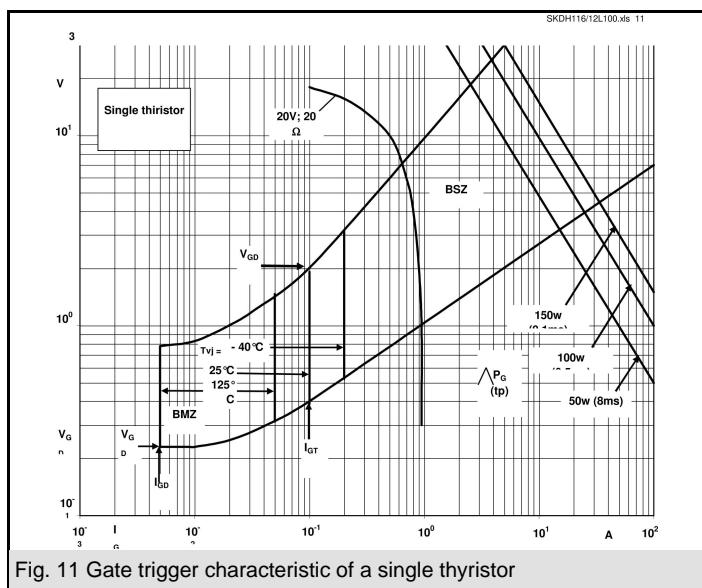


Fig. 11 Gate trigger characteristic of a single thyristor

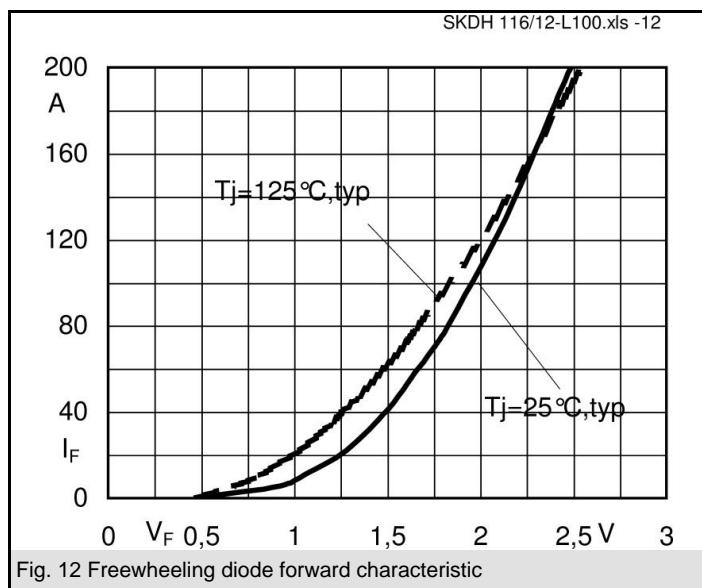
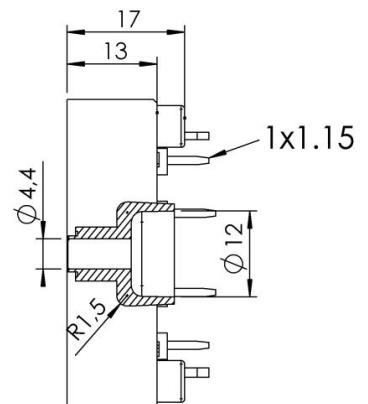
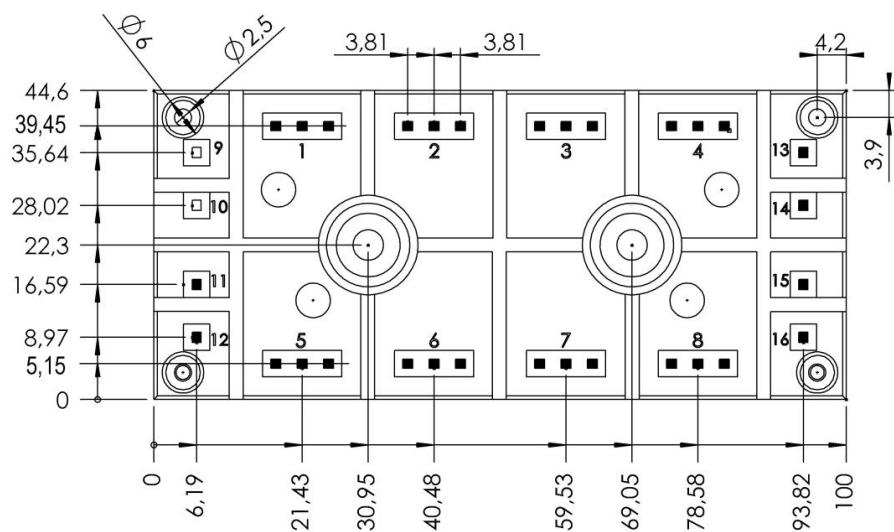
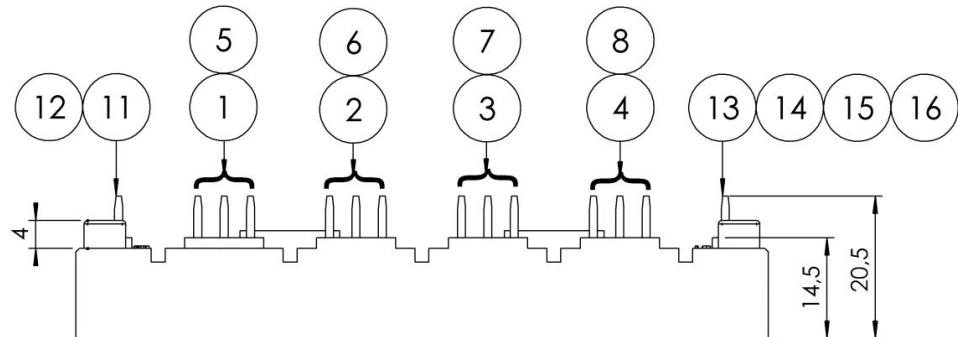


Fig. 12 Freewheeling diode forward characteristic

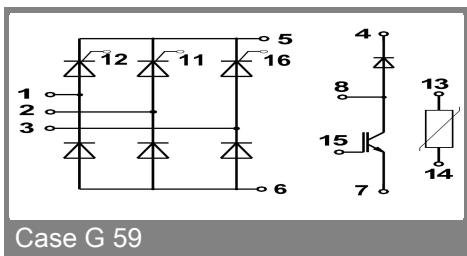
SKDH 116/.. -L100

UL recognized
File n° E63 532

Dimensions in mm



Case G 59



Case G 59

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.